



BAS299

HIGH SPEED HIGH CURRENT QUAD SWITCHING DIODE

Features

- High-Switching Speed, High Current
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- · Qualified to AEC-Q101 Standards for High Reliability

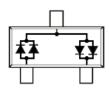
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208⁽³⁾
- Polarity: See Diagram
- Weight: 0.01 grams (Approximate)

SOT23



Top View



Top View Internal Schematic

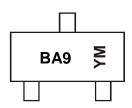
Ordering Information (Note 4)

Ī	Part Number	Compliance	Case	Packaging
	BAS299-7	Standard	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



BA9 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	2019	2	020	2021	202	2	2023	202	24	2025	:	2026
Code	G		Н	ı	J		K	L		М		N
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	100	V
Forward Continuous Current (Note 5) Single diode loaded by design Double diode loaded		I _{FM}	430 300	mA mA
Repetitive Peak Forward Current		I _{FRM}	900	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0ms @ t = 1.0s	I _{FSM}	9.0 3.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ heta JA}$	417	°C/W
Operating and Storage Temperature Range	T_J,T_STG	-65 to +150	°C

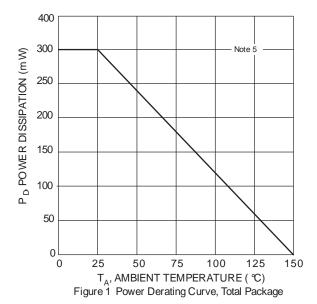
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

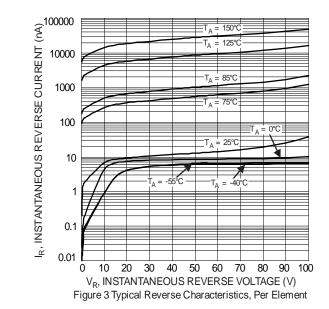
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	100	_	V	$I_R = 2.5\mu A$
Forward Voltage	VF	_	0.715 0.855 1.0 1.2	V	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA I _F = 300mA
Reverse Current (Note 6)	I _R	_	30 1 30 60	nA μA μA μA	$V_R = 25V$ $V_R = 100V$ $V_R = 25V, T_J = +150^{\circ}C$ $V_R = 100V, T_J = +150^{\circ}C$
Total Capacitance	C _T	_	3.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	6.0	ns	$\begin{aligned} I_F &= I_R = 10 \text{mA}, \\ I_{rr} &= 0.1 \times I_R, \ R_L = 100 \Omega \end{aligned}$
Forward Recovery Voltage	V_{fr}		1.75	V	When Switched From IF = 10mA, tr = 20ns

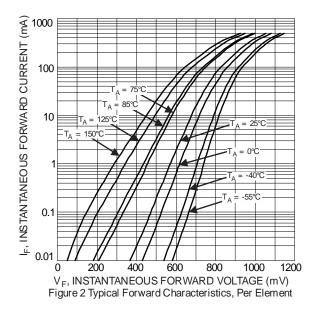
Notes:

- 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com. 6. Short duration pulse test used to minimize self-heating effect.









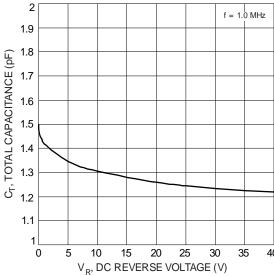
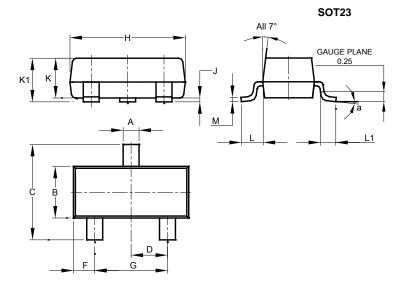


Figure 4 Total Capacitance vs Reverse Voltage, Per Element



Package Outline Dimensions

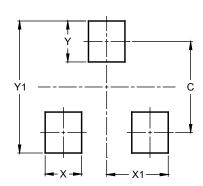
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
M	0.085	0.150	0.110				
а	0°	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
C	2.0
Х	0.8
X1	1.35
Υ	0.9
Y1	2.9



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